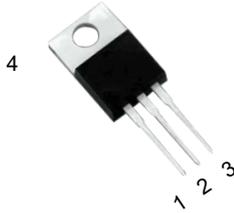


# SMOS100N10A2 SMOS100N10A6

## N Channel Power MOSFET

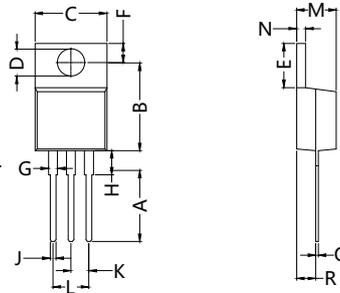
SMOS100N10A2

TO-220AB



- 1, Gate
- 2, Drain
- 3, Source
- 4, Drain Fin

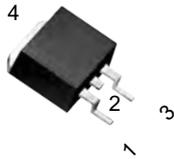
Dimensions TO-220AB



Dim.	Millimeter	
	Min.	Max.
A	12.70	13.97
B	14.73	16.00
C	9.91	10.66
ØD	3.54	4.08
E	5.85	6.85
F	2.54	3.18
G	1.15	1.65
H	2.79	5.84
J	0.64	1.01
K	2.45BSC	
L	5.05BSC	
M	4.32	4.82
N	1.14	1.39
Q	0.35	0.56
R	2.29	2.79

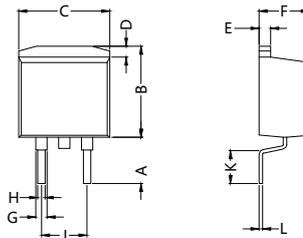
SMOS100N10A6

TO-263(D<sup>2</sup>PAK)

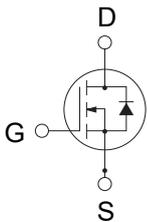


- 1, Gate
- 2, Drain
- 3, Source
- 4, Drain Fin

Dimensions TO-263 (D<sup>2</sup>PAK)



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	5.00	5.60	0.197	0.220
B	9.32	10.52	0.367	0.414
C	9.60	10.40	0.378	0.409
D	1.10	1.40	0.043	0.055
E	1.20	1.50	0.047	0.059
F	4.32	4.82	0.170	0.190
G	1.15	1.65	0.045	0.065
H	0.64	1.00	0.025	0.039
J	4.80	5.20	0.189	0.205
K	2.80	3.90	0.110	0.154
L	0.30	0.45	0.012	0.018



G=Gate, D=Drain, S=Source

### Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	100	V	
Gate-Source Voltage	V <sub>GS</sub>	±20	V	
Drain Current-Continuous(T <sub>C</sub> =25°C)	I <sub>D25</sub>	100	A	
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D100</sub>	90	A	
Pulsed Drain Current	I <sub>DM</sub>	400	A	
Maximum Power Dissipation	TO-220	P <sub>D</sub>	140	W
	TO-263	P <sub>D</sub>	128	W
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	190	mJ	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 To 150	°C	

### Thermal Characteristic

Thermal Resistance,Junction-to-Case (TO-220AB)	R <sub>θJC</sub>	0.88	°C/W
Thermal Resistance,Junction-to-Case (TO-263)	R <sub>θJC</sub>	0.92	°C/W



# SMOS100N10A2 SMOS100N10A6

## N Channel Power MOSFET

### Electrical Characteristics

(T<sub>J</sub>=25°C, unless otherwise specified)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>SG</sub> = 0V, I <sub>D</sub> = 250μA	100	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	-	-	±100	nA
<b>On Characteristics</b> (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2	3	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 20A	-	6.6	8.0	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 50A	-	115.0	-	S
<b>Dynamic Characteristics</b> (Note 4)						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, F = 1.0MHz	-	3130	-	PF
Output Capacitance	C <sub>oss</sub>		-	525	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	10	-	PF
<b>Switching Characteristics</b> (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 50V, I <sub>D</sub> = 50A V <sub>GS</sub> = 10V, R <sub>G</sub> = 2.7Ω	-	18	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	9.9	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	63	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	44	-	nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DD</sub> = 50V, I <sub>D</sub> = 50A, V <sub>GS</sub> = 10V, f = 1MHz	-	45	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	8.2	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	11	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-	0.80	1.3	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	100	A
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 30A di/dt = 100A/μs (Note 3)	-	65	-	nS
Reverse Recovery Charge	Q <sub>rr</sub>				156	-
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition : T<sub>J</sub> = 25°C, V<sub>DD</sub> = 30V, V<sub>G</sub> = 10V, L = 0.4mH, R<sub>G</sub> = 25Ω



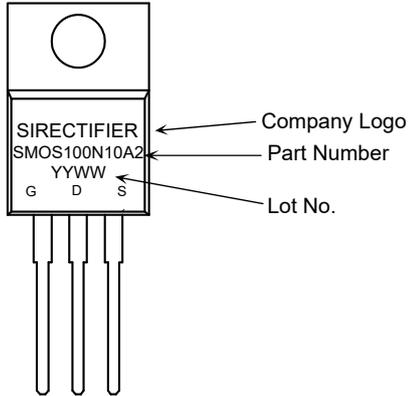
# SMOS100N10A2 SMOS100N10A6

## N Channel Power MOSFET

### Marking

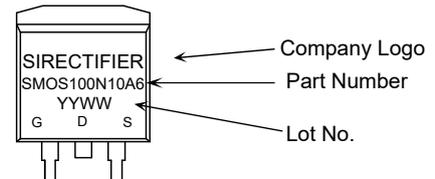
**SMOS100N10A2**

(TO-220AB)



**SMOS100N10A6**

(TO-263)

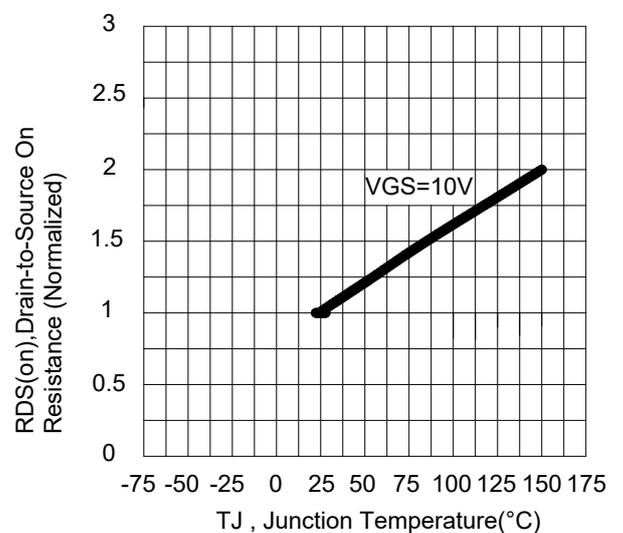
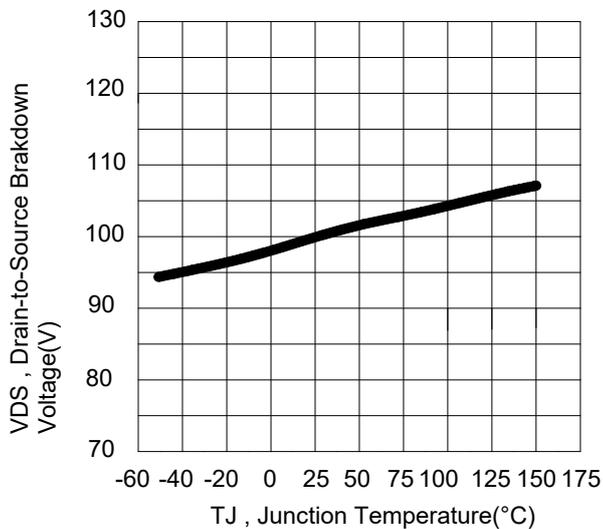
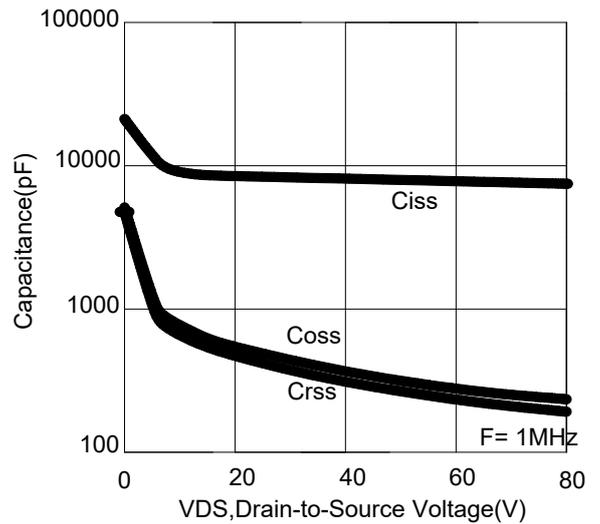
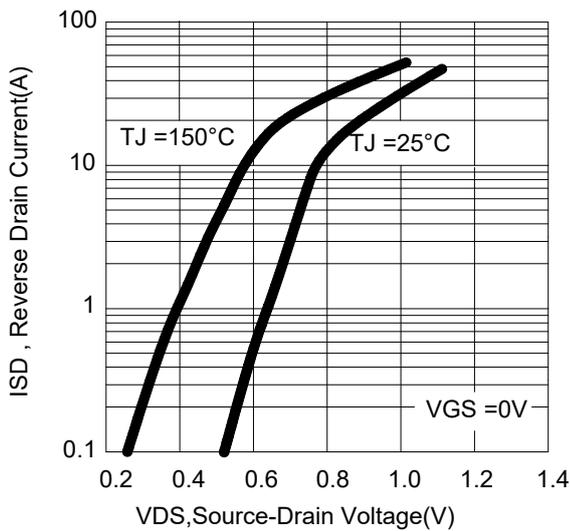
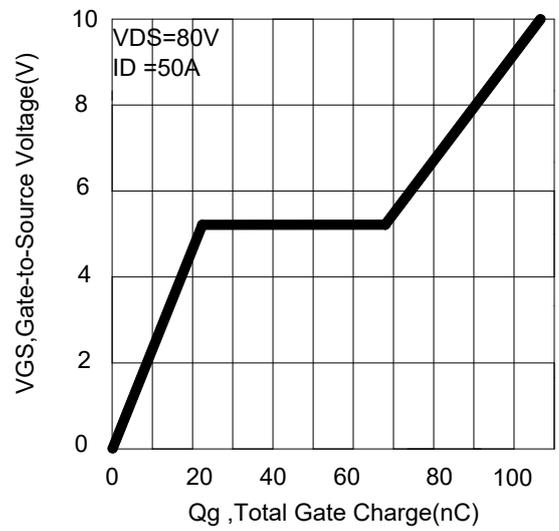
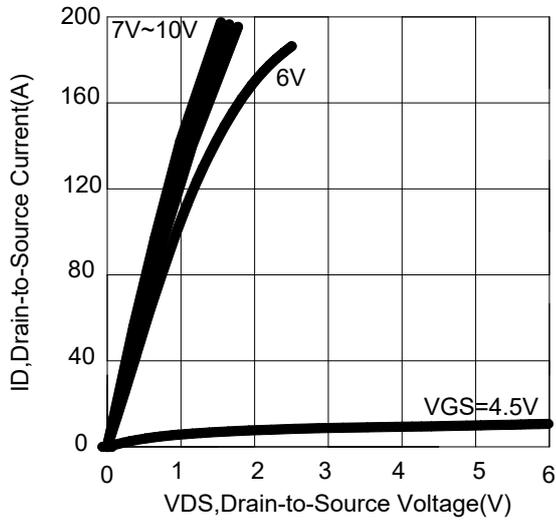


### Ordering Information

Part Number	Package	Shipping	Marking Code
<b>SMOS100N10A2</b>	TO-220AB	50pcs / Tube	SMOS100N10A2
<b>SMOS100N10A6</b>	TO-263	50pcs / Tube or 1000pcs / Tape & Reel	SMOS100N10A6

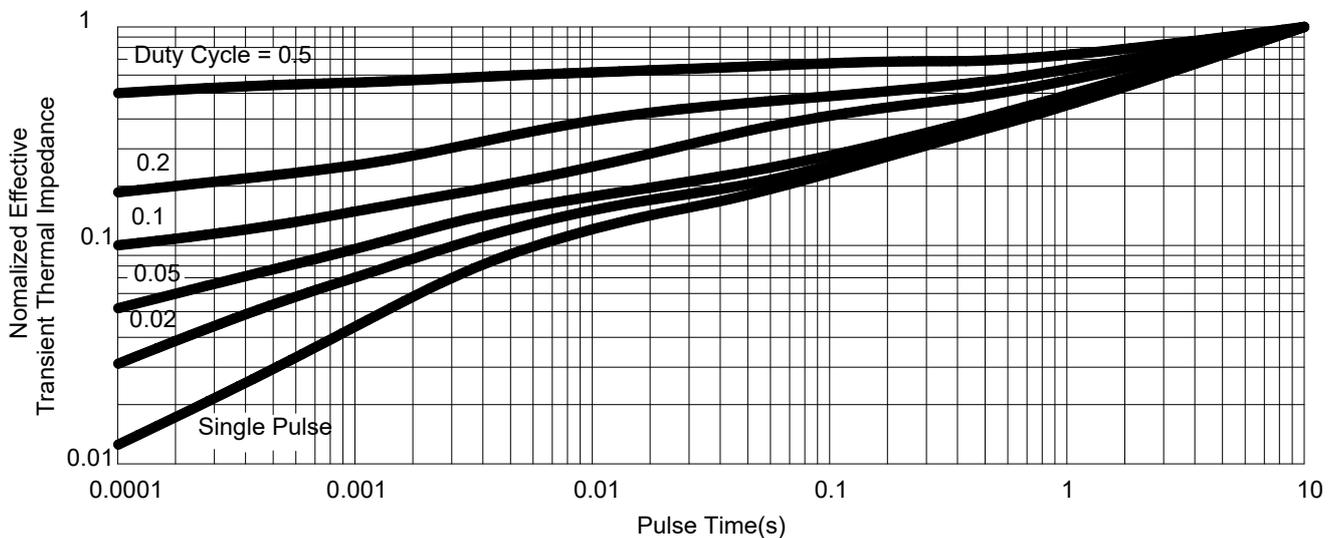
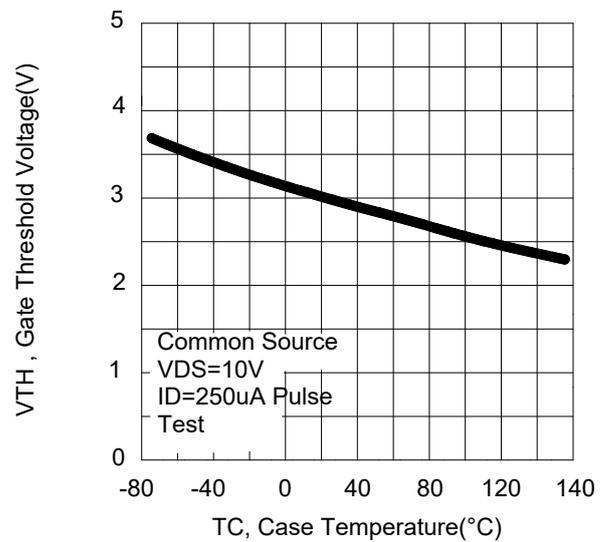
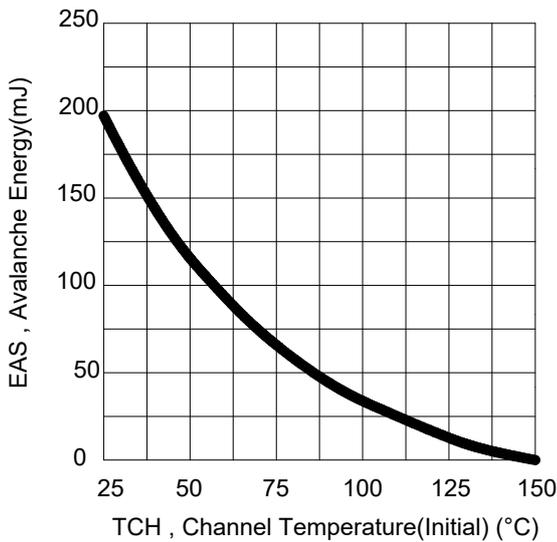
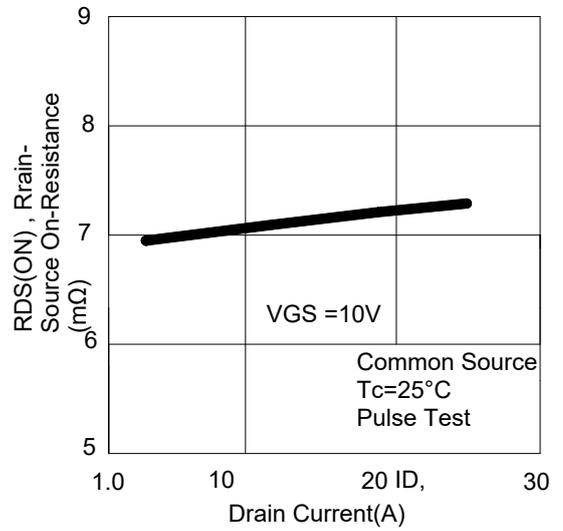
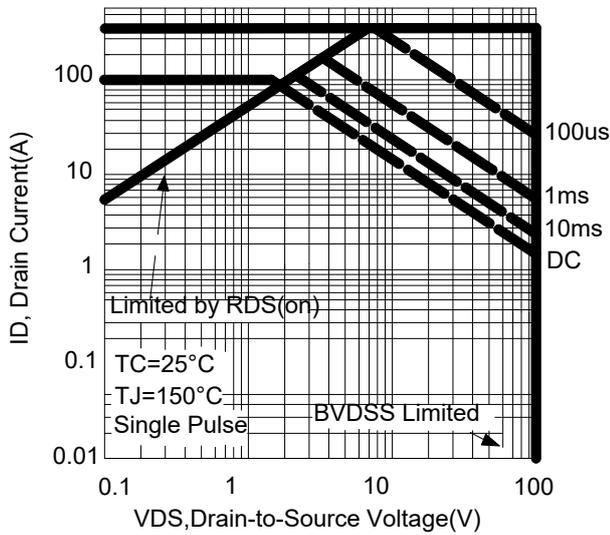
# SMOS100N10A2 SMOS100N10A6

## N Channel Power MOSFET



# SMOS100N10A2 SMOS100N10A6

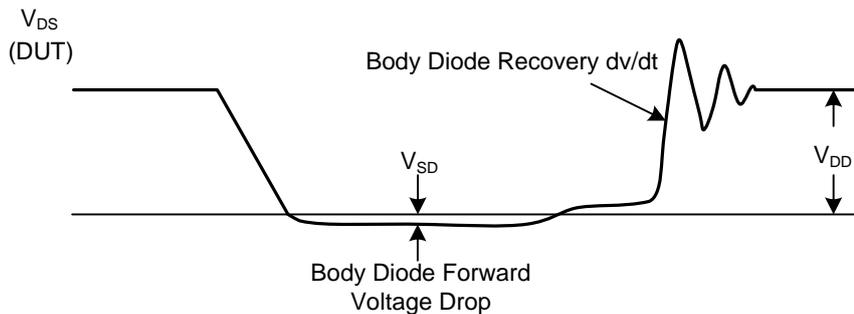
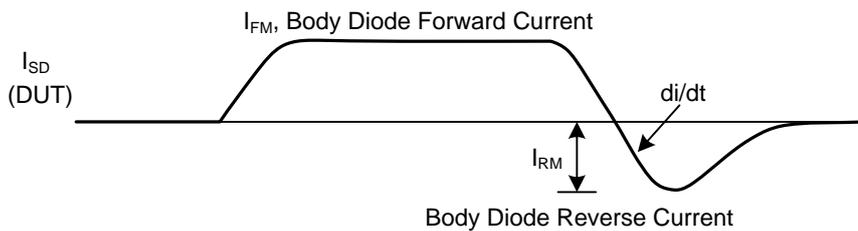
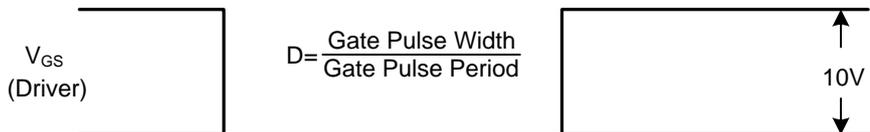
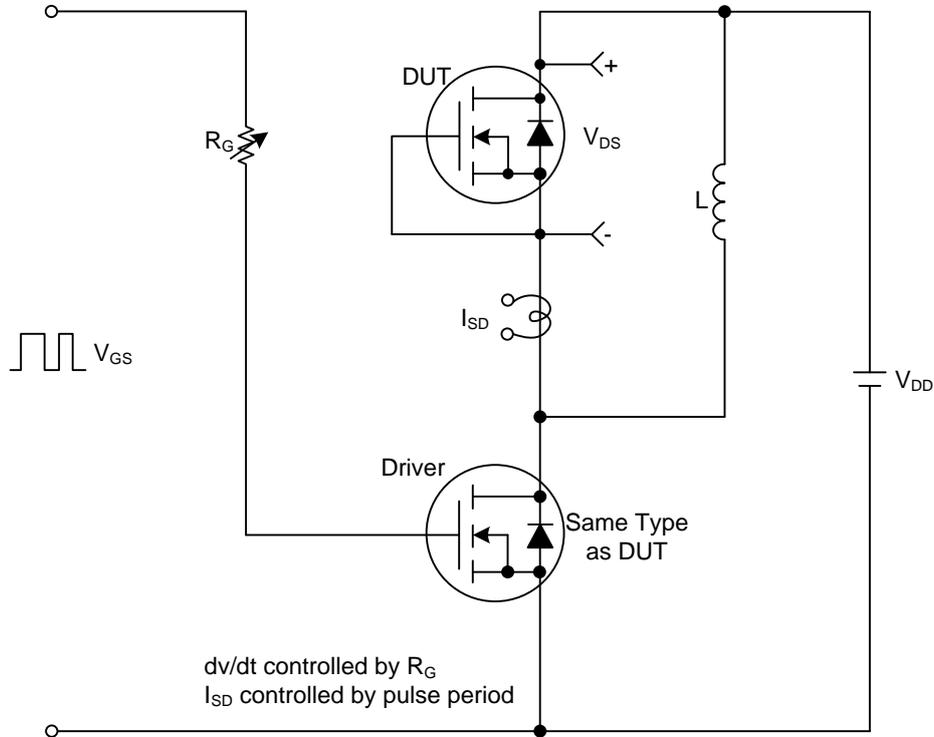
## N Channel Power MOSFET



# SMOS100N10A2 SMOS100N10A6

## N Channel Power MOSFET

Peak Diode Recovery dv/dt Test Circuit & Waveforms



# SMOS100N10A2 SMOS100N10A6

## N Channel Power MOSFET

